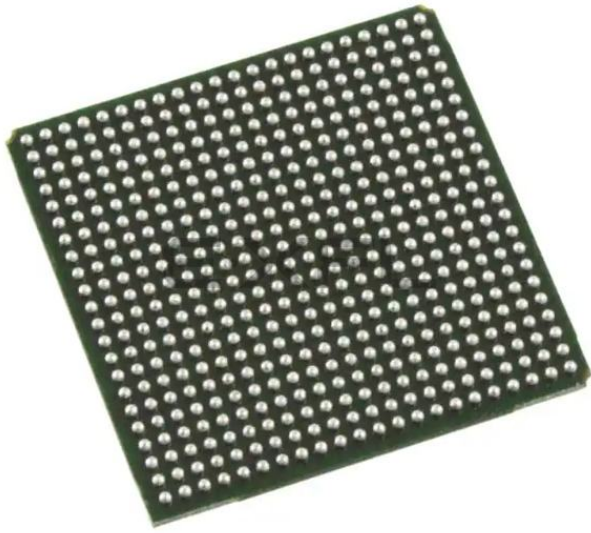




Welcome to [E-XFL.COM](https://www.e-xfl.com)

Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

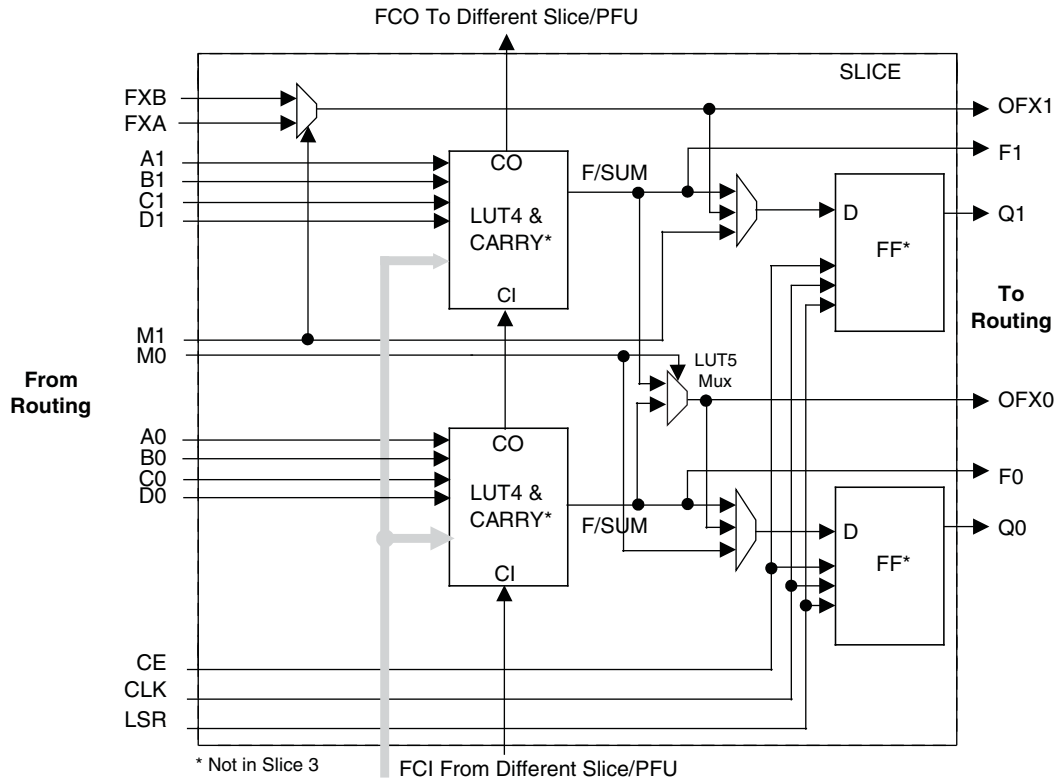
Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Obsolete
Number of LABs/CLBs	4000
Number of Logic Elements/Cells	32000
Total RAM Bits	339968
Number of I/O	331
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-35se-7f484c

Figure 2-4. Slice Diagram



For Slices 0 and 2, memory control signals are generated from Slice 1 as follows:

WCK is CLK
WRE is from LSR
DI[3:2] for Slice 2 and DI[1:0] for Slice 0 data
WAD [A:D] is a 4bit address from slice 1 LUT input

Table 2-2. Slice Signal Descriptions

Function	Type	Signal Names	Description
Input	Data signal	A0, B0, C0, D0	Inputs to LUT4
Input	Data signal	A1, B1, C1, D1	Inputs to LUT4
Input	Multi-purpose	M0	Multipurpose Input
Input	Multi-purpose	M1	Multipurpose Input
Input	Control signal	CE	Clock Enable
Input	Control signal	LSR	Local Set/Reset
Input	Control signal	CLK	System Clock
Input	Inter-PFU signal	FC	Fast Carry-in ¹
Input	Inter-slice signal	FXA	Intermediate signal to generate LUT6 and LUT7
Input	Inter-slice signal	FXB	Intermediate signal to generate LUT6 and LUT7
Output	Data signals	F0, F1	LUT4 output register bypass signals
Output	Data signals	Q0, Q1	Register outputs
Output	Data signals	OFX0	Output of a LUT5 MUX
Output	Data signals	OFX1	Output of a LUT6, LUT7, LUT8 ² MUX depending on the slice
Output	Inter-PFU signal	FCO	Slice 2 of each PFU is the fast carry chain output ¹

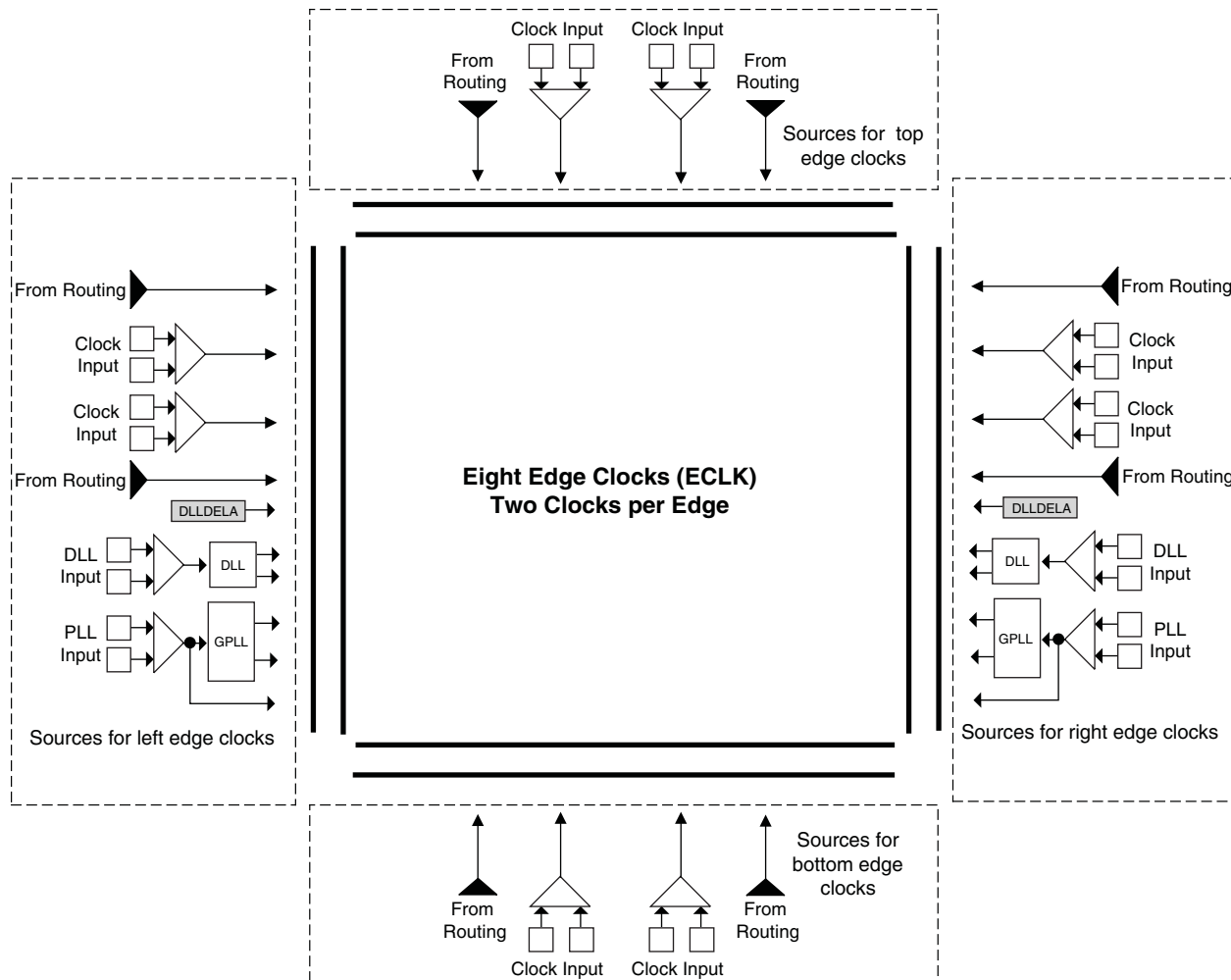
1. See Figure 2-4 for connection details.

2. Requires two PFUs.

Edge Clock Sources

Edge clock resources can be driven from a variety of sources at the same edge. Edge clock resources can be driven from adjacent edge clock PIOs, primary clock PIOs, PLLs/DLLs and clock dividers as shown in Figure 2-12.

Figure 2-12. Edge Clock Sources



sysMEM Memory

LatticeECP2/M devices contains a number of sysMEM Embedded Block RAM (EBR). The EBR consists of an 18-Kbit RAM with dedicated input and output registers.

sysMEM Memory Block

The sysMEM block can implement single port, dual port or pseudo dual port memories. Each block can be used in a variety of depths and widths as shown in Table 2-6. FIFOs can be implemented in sysMEM EBR blocks by implementing support logic with PFUs. The EBR block facilitates parity checking by supporting an optional parity bit for each data byte. EBR blocks provide byte-enable support for configurations with 18-bit and 36-bit data widths.

Table 2-6. sysMEM Block Configurations

Memory Mode	Configurations
Single Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36
True Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18
Pseudo Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36

Bus Size Matching

All of the multi-port memory modes support different widths on each of the ports. The RAM bits are mapped LSB word 0 to MSB word 0, LSB word 1 to MSB word 1, and so on. Although the word size and number of words for each port varies, this mapping scheme applies to each port.

RAM Initialization and ROM Operation

If desired, the contents of the RAM can be pre-loaded during device configuration. By preloading the RAM block during the chip configuration cycle and disabling the write controls, the sysMEM block can also be utilized as a ROM.

Memory Cascading

Larger and deeper blocks of RAM can be created using EBR sysMEM Blocks. Typically, the Lattice design tools cascade memory transparently, based on specific design inputs.

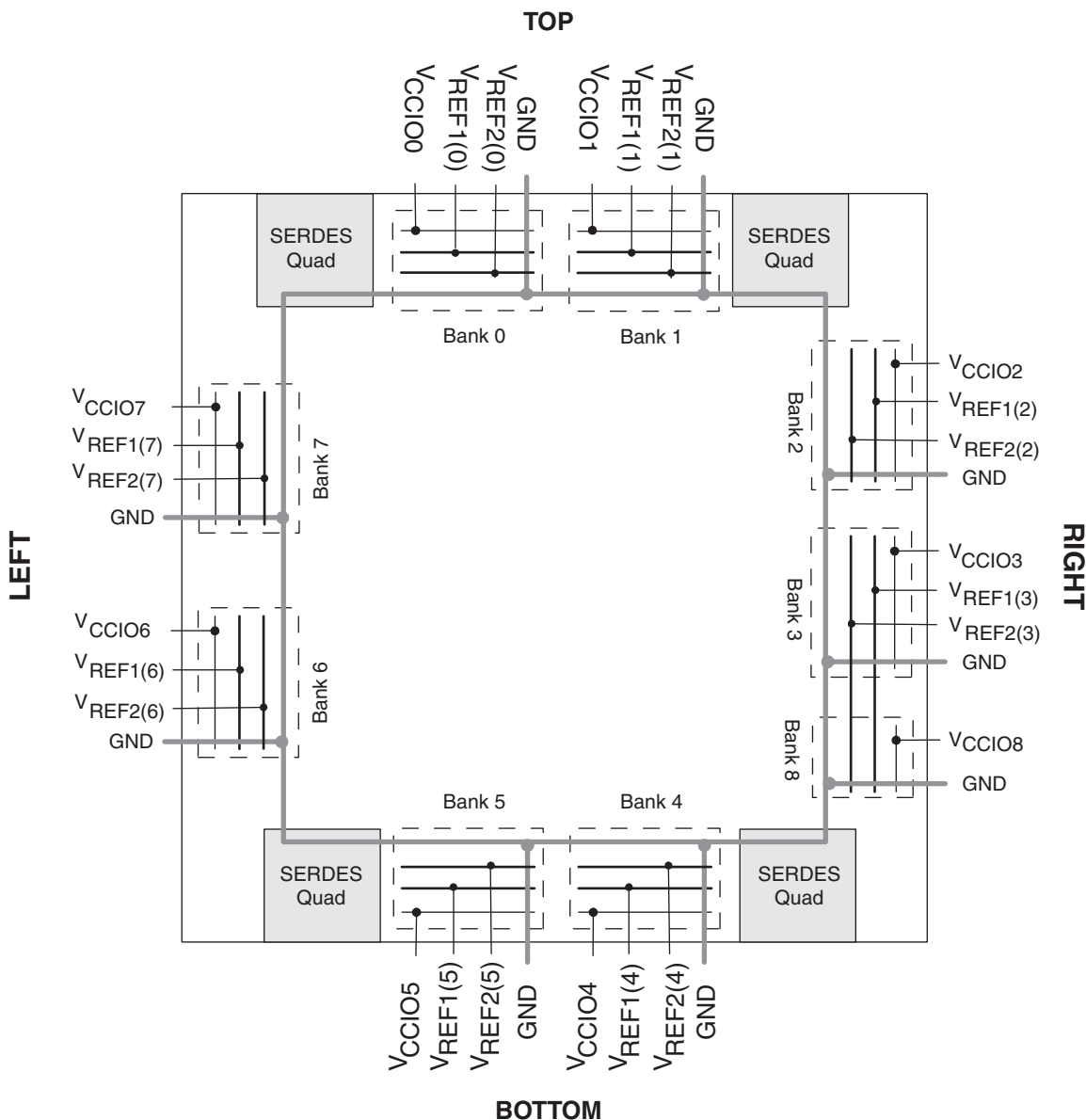
Single, Dual and Pseudo-Dual Port Modes

In all the sysMEM RAM modes the input data and address for the ports are registered at the input of the memory array. The output data of the memory is optionally registered at the output.

EBR memory supports two forms of write behavior for single port or dual port operation:

1. Normal – Data on the output appears only during a read cycle. During a write cycle, the data (at the current address) does not appear on the output. This mode is supported for all data widths.

Figure 2-38. LatticeECP2M Banks



LatticeECP2/M devices contain two types of sysI/O buffer pairs.

1. **Top (Bank 0 and Bank 1) sysI/O Buffer Pairs (Single-Ended Outputs Only)**

The sysI/O buffer pairs in the top banks of the device consist of two single-ended output drivers and two sets of single-ended input buffers (both ratioed and referenced). One of the referenced input buffers can also be configured as a differential input.

The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

2. **Bottom (Bank 4 and Bank 5) sysI/O Buffer Pairs (Single-Ended Outputs Only)**

The sysI/O buffer pairs in the bottom banks of the device consist of two single-ended output drivers and two

Typical Building Block Function Performance¹

Pin-to-Pin Performance (LVCMOS25 12mA Drive)

Function	-7 Timing	Units
Basic Functions		
16-bit Decoder	3.8	ns
32-bit Decoder	4.5	ns
64-bit Decoder	5.0	ns
4:1 MUX	3.2	ns
8:1 MUX	3.4	ns
16:1 MUX	3.5	ns
32:1 MUX	4.0	ns

1. These timing numbers were generated using the ispLEVER 8.0 design tool. Exact performance may vary with device and tool version. The tool uses internal parameters that have been characterized but are not tested on every device.

Register-to-Register Performance

Function	-7 Timing	Units
Basic Functions		
16-bit Decoder	599	MHz
32-bit Decoder	542	MHz
64-bit Decoder	417	MHz
4:1 MUX	847	MHz
8:1 MUX	803	MHz
16:1 MUX	660	MHz
32:1 MUX	577	MHz
8-bit Adder	591	MHz
16-bit Adder	500	MHz
64-bit Adder	306	MHz
16-bit Counter	488	MHz
32-bit Counter	378	MHz
64-bit Counter	260	MHz
64-bit Accumulator	253	MHz
Embedded Memory Functions		
512x36 Single Port RAM, EBR Output Registers	370	MHz
1024x18 True-Dual Port RAM (Write Through or Normal, EBR Output Registers)	370	MHz
1024x18 True-Dual Port RAM (Write Through or Normal, PLC Output Registers)	280	MHz
Distributed Memory Functions		
16x4 Pseudo-Dual Port RAM (One PFU)	819	MHz
32x4 Pseudo-Dual Port RAM	521	MHz
64x8 Pseudo-Dual Port RAM	435	MHz
DSP Functions		
18x18 Multiplier (All Registers)	420	MHz
9x9 Multiplier (All Registers)	420	MHz

Signal Descriptions (Cont.)

Signal Name	I/O	Description
[LOC]DQS[num]	I/O	DQ input/output pads: T (top), R (right), B (bottom), L (left), DQS, num = ball function number.
[LOC]DQ[num]	I/O	DQ input/output pads: T (top), R (right), B (bottom), L (left), DQ, associated DQS number.
Test and Programming (Dedicated Pins)		
TMS	I	Test Mode Select input, used to control the 1149.1 state machine. Pull-up is enabled during configuration.
TCK	I	Test Clock input pin, used to clock the 1149.1 state machine. No pull-up enabled.
TDI	I	Test Data in pin. Used to load data into device using 1149.1 state machine. After power-up, this TAP port can be activated for configuration by sending appropriate command. (Note: once a configuration port is selected it is locked. Another configuration port cannot be selected until the power-up sequence). Pull-up is enabled during configuration.
TDO	O	Output pin. Test Data Out pin used to shift data out of a device using 1149.1.
VCCJ	—	Power supply pin for JTAG Test Access Port.
Configuration Pads (Used During sysCONFIG)		
CFG[2:0]	I	Mode pins used to specify configuration mode values latched on rising edge of INITN. During configuration, a pull-up is enabled. These are dedicated pins.
INITN	I/O	Open Drain pin. Indicates the FPGA is ready to be configured. During configuration, a pull-up is enabled. It is a dedicated pin.
PROGRAMN	I	Initiates configuration sequence when asserted low. This pin always has an active pull-up. This is a dedicated pin.
DONE	I/O	Open Drain pin. Indicates that the configuration sequence is complete, and the startup sequence is in progress. This is a dedicated pin.
CCLK	I/O	Configuration Clock for configuring an FPGA in sysCONFIG mode.
BUSY/SISPI	I/O	Read control command in SPI or SPI _m mode.
CSN	I	sysCONFIG chip select (active low). During configuration, a pull-up is enabled.
CS1N	I	sysCONFIG chip select (active low). During configuration, a pull-up is enabled.
WRITEN	I	Write Data on Parallel port (active low).
D[0]/SPIFASTN	I/O	sysCONFIG Port Data I/O for Parallel mode. sysCONFIG Port Data I/O for SPI or SPI _m . When using the SPI or SPI _m mode, this pin should either be tied high or low, must not be left floating.
D[1:6]	I/O	sysCONFIG Port Data I/O for Parallel
D[7]/SPID0	I/O	sysCONFIG Port Data I/O for Parallel, SPI, SPI _m
DOUT/CSN	O	Output for serial configuration data (rising edge of CCLK) when using sysCONFIG port.
DI/CSSPI0N	I/O	Input for serial configuration data (clocked with CCLK) when using sysCONFIG port. During configuration, a pull-up is enabled. Output when used in SPI/SPI _m modes.
Dedicated SERDES Signals^{1, 2, 3}		
[LOC]_SQ_VCCAUX33	—	Termination resistor switching power (3.3V). This pin must be tied to 3.3V even if the quad is unused.
[LOC]_SQ_REFCLKN	I	Negative Reference Clock Input
[LOC]_SQ_REFCLKP	I	Positive Reference Clock Input
[LOC]_SQ_VCCP	—	PLL and Reference clock buffer power (1.2V). This pin must be tied to 1.2V even if the quad is unused.

LatticeECP2M Pin Information Summary, LFE2M20 and LFE2M35 (Cont.)

Pin Type		LFE2M20		LFE2M35		
		256 fpBGA	484 fpBGA	256 fpBGA	484 fpBGA	672 fpBGA
Available DDR-Interfaces per I/O Bank ¹	Bank0	0	0	0	0	0
	Bank1	0	0	0	0	0
	Bank2	0	1	0	1	3
	Bank3	0	1	0	1	2
	Bank4	2	4	2	4	3
	Bank5	1	2	1	2	3
	Bank6	0	3	0	1	2
	Bank7	1	2	1	2	3
	Bank8	0	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0	0
	Bank1	0	0	0	0	0
	Bank2	0	0	0	0	0
	Bank3	0	0	0	0	0
	Bank4	32	62	32	62	50
	Bank5	20	28	20	28	60
	Bank6	16	40	16	39	52
	Bank7	28	40	28	40	60
	Bank8	0	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

Available Device Resources by Package, LatticeECP2

Resource	Device	256 fpBGA	484 fpBGA	672 fpBGA	900 fpBGA
PLL/DLL	ECP2-6	4	—	—	—
	ECP2-12	4	4	—	—
	ECP2-20	4	4	4	—
	ECP2-35	—	4	4	—
	ECP2-50	—	6	6	—
	ECP2-70	—	—	8	8

Available Device Resources by Package, LatticeECP2M

Resource	Device	256 fpBGA	484 fpBGA	672 fpBGA	900 fpBGA	1152 fpBGA
PLL/DLL	ECP2M20	10	10	—	—	—
	ECP2M35	10	10	10	—	—
	ECP2M50	—	10	10	10	—
	ECP2M70	—	—	—	10	10
	ECP2M100	—	—	—	10	10

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AA14	PB29B	5	BDQ33	C	PB29B	5	BDQ33	C	
AE10	PB30A	5	BDQ33	T	PB30A	5	BDQ33	T	
AF10	PB30B	5	BDQ33	C	PB30B	5	BDQ33	C	
W14	PB31A	5	BDQ33	T	PB31A	5	BDQ33	T	
AB13	PB31B	5	BDQ33	C	PB31B	5	BDQ33	C	
VCCIO	VCCIO5	5			VCCIO5	5			
Y14	PB32A	5	BDQ33	T	PB32A	5	BDQ33	T	
AB14	PB32B	5	BDQ33	C	PB32B	5	BDQ33	C	
GND	GNDIO5	-			GNDIO5	-			
AE11	PB33A	5	BDQS33	T	PB33A	5	BDQS33	T	
AF11	PB33B	5	BDQ33	C	PB33B	5	BDQ33	C	
AD14	PB34A	5	BDQ33	T	PB34A	5	BDQ33	T	
AA15	PB34B	5	BDQ33	C	PB34B	5	BDQ33	C	
AE12	PB35A	5	PCLKT5_0/BDQ33	T	PB35A	5	PCLKT5_0/BDQ33	T	
AF12	PB35B	5	PCLKC5_0/BDQ33	C	PB35B	5	PCLKC5_0/BDQ33	C	
VCCIO	VCCIO5	5			VCCIO5	5			
GND	GNDIO5	-			GNDIO5	-			
AD15	PB40A	4	PCLKT4_0/BDQ42	T	PB40A	4	PCLKT4_0/BDQ42	T	
VCCIO	VCCIO4	4			VCCIO4	4			
AC15	PB40B	4	PCLKC4_0/BDQ42	C	PB40B	4	PCLKC4_0/BDQ42	C	
AE13	PB41A	4	BDQ42	T	PB41A	4	BDQ42	T	
AF13	PB41B	4	BDQ42	C	PB41B	4	BDQ42	C	
AB17	PB42A	4	BDQS42	T	PB42A	4	BDQS42	T	
GND	GNDIO4	-			GNDIO4	-			
Y15	PB42B	4	BDQ42	C	PB42B	4	BDQ42	C	
AE14	PB43A	4	BDQ42	T	PB43A	4	BDQ42	T	
AF14	PB43B	4	BDQ42	C	PB43B	4	BDQ42	C	
AA16	PB44A	4	BDQ42	T	PB44A	4	BDQ42	T	
VCCIO	VCCIO4	4			VCCIO4	4			
W15	PB44B	4	BDQ42	C	PB44B	4	BDQ42	C	
AC17	PB45A	4	BDQ42	T	PB45A	4	BDQ42	T	
AB16	PB45B	4	BDQ42	C	PB45B	4	BDQ42	C	
AE15	PB46A	4	BDQ42	T	PB46A	4	BDQ42	T	
GND	GNDIO4	-			GNDIO4	-			
AF15	PB46B	4	BDQ42	C	PB46B	4	BDQ42	C	
AE16	PB47A	4	BDQ51	T	PB47A	4	BDQ51	T	
AF16	PB47B	4	BDQ51	C	PB47B	4	BDQ51	C	
Y16	PB48A	4	BDQ51	T	PB48A	4	BDQ51	T	
AB18	PB48B	4	BDQ51	C	PB48B	4	BDQ51	C	
AD17	PB49A	4	BDQ51	T	PB49A	4	BDQ51	T	
AD18	PB49B	4	BDQ51	C	PB49B	4	BDQ51	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AC18	PB50A	4	BDQ51	T	PB50A	4	BDQ51	T	
AD19	PB50B	4	BDQ51	C	PB50B	4	BDQ51	C	
GND	GNDIO4	-			GNDIO4	-			
AC19	PB51A	4	BDQS51	T	PB51A	4	BDQS51	T	

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
Y21	PB64A	4	VREF2_4/BDQ60	T	PB73A	4	VREF2_4/BDQ69	T	
AB23	PB64B	4	VREF1_4/BDQ60	C	PB73B	4	VREF1_4/BDQ69	C	
GND	GNDIO4	-			GNDIO4	-			
AD24	CFG2	8			CFG2	8			
W20	CFG1	8			CFG1	8			
AC24	CFG0	8			CFG0	8			
V19	PROGRAMN	8			PROGRAMN	8			
AA22	CCLK	8			CCLK	8			
AB24	INITN	8			INITN	8			
AD25	DONE	8			DONE	8			
GND	GNDIO8	-			GNDIO8	-			
W21	PR44B	8	WRITEN	C	PR58B	8	WRITEN	C	
Y22	PR44A	8	CS1N	T	PR58A	8	CS1N	T	
AC25	PR43B	8	CSN	C	PR57B	8	CSN	C	
AB25	PR43A	8	D0/SPIFASTN	T	PR57A	8	D0/SPIFASTN	T	
VCCIO	VCCIO8	8			VCCIO8	8			
AD26	PR42B	8	D1	C	PR56B	8	D1	C	
AC26	PR42A	8	D2	T	PR56A	8	D2	T	
Y23	PR41B	8	D3	C	PR55B	8	D3	C	
GND	GNDIO8	-			GNDIO8	-			
W22	PR41A	8	D4	T	PR55A	8	D4	T	
AA25	PR40B	8	D5	C	PR54B	8	D5	C	
AB26	PR40A	8	D6	T	PR54A	8	D6	T	
W23	PR39B	8	D7/SPID0	C	PR53B	8	D7/SPID0	C	
VCCIO	VCCIO8	8			VCCIO8	8			
V22	PR39A	8	DI/CSSPI0N	T	PR53A	8	DI/CSSPI0N	T	
Y24	PR38B	8	DOU/CSON	C	PR52B	8	DOU/CSON	C	
Y25	PR38A	8	BUSY/SISPI	T	PR52A	8	BUSY/SISPI	T	
W24	PR37B	3	RDQ34	C	PR51B	3	RDQ48	C	
GND	GNDIO3	-			GNDIO3	-			
V23	PR37A	3	RDQ34	T	PR51A	3	RDQ48	T	
AA26	PR36B	3	RDQ34	C (LVDS)*	PR50B	3	RDQ48	C (LVDS)*	
Y26	PR36A	3	RDQ34	T (LVDS)*	PR50A	3	RDQ48	T (LVDS)*	
U21	PR35B	3	RDQ34	C	PR49B	3	RDQ48	C	
VCCIO	VCCIO3	3			VCCIO3	3			
U19	PR35A	3	RDQ34	T	PR49A	3	RDQ48	T	
W25	PR34B	3	RDQ34	C (LVDS)*	PR48B	3	RDQ48	C (LVDS)*	
W26	PR34A	3	RDQS34	T (LVDS)*	PR48A	3	RDQS48	T (LVDS)*	
GND	GNDIO3	-			GNDIO3	-			
V24	PR33B	3	RDQ34	C	PR47B	3	RDQ48	C	
V25	PR33A	3	RDQ34	T	PR47A	3	RDQ48	T	
V26	PR32B	3	RDQ34	C (LVDS)*	PR46B	3	RDQ48	C (LVDS)*	
U26	PR32A	3	RDQ34	T (LVDS)*	PR46A	3	RDQ48	T (LVDS)*	
VCCIO	VCCIO3	3			VCCIO3	3			
U22	PR31B	3	RLM0_GPLL_C_FB_A/RDQ34	C	PR45B	3	RLM0_GPLL_C_FB_A/RDQ48	C	
U23	PR31A	3	RLM0_GPLL_T_FB_A/RDQ34	T	PR45A	3	RLM0_GPLL_T_FB_A/RDQ48	T	

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
Y21	PB82A	4	VREF2_4/BDQ78	T	PB100A	4	VREF2_4/BDQ96	T
AB23	PB82B	4	VREF1_4/BDQ78	C	PB100B	4	VREF1_4/BDQ96	C
GND	GNDIO4	-			GNDIO4	-		
AD24	CFG2	8			CFG2	8		
W20	CFG1	8			CFG1	8		
AC24	CFG0	8			CFG0	8		
V19	PROGRAMN	8			PROGRAMN	8		
AA22	CCLK	8			CCLK	8		
AB24	INITN	8			INITN	8		
AD25	DONE	8			DONE	8		
GND	GNDIO8	-			GNDIO8	-		
W21	PR77B	8	WRITEN	C	PR90B	8	WRITEN	C
Y22	PR77A	8	CS1N	T	PR90A	8	CS1N	T
AC25	PR76B	8	CSN	C	PR89B	8	CSN	C
AB25	PR76A	8	D0/SPIFASTN	T	PR89A	8	D0/SPIFASTN	T
VCCIO	VCCIO8	8			VCCIO8	8		
AD26	PR75B	8	D1	C	PR88B	8	D1	C
AC26	PR75A	8	D2	T	PR88A	8	D2	T
Y23	PR74B	8	D3	C	PR87B	8	D3	C
GND	GNDIO8	-			GNDIO8	-		
W22	PR74A	8	D4	T	PR87A	8	D4	T
AA25	PR73B	8	D5	C	PR86B	8	D5	C
AB26	PR73A	8	D6	T	PR86A	8	D6	T
W23	PR72B	8	D7/SPID0	C	PR85B	8	D7/SPID0	C
VCCIO	VCCIO8	8			VCCIO8	8		
V22	PR72A	8	DI/CSSPI0N	T	PR85A	8	DI/CSSPI0N	T
Y24	PR71B	8	DOUT/CSON	C	PR84B	8	DOUT/CSON	C
Y25	PR71A	8	BUSY/SISPI	T	PR84A	8	BUSY/SISPI	T
W24	PR70B	3	RDQ67	C	PR83B	3	RDQ80	C
GND	GNDIO3	-			GNDIO3	-		
V23	PR70A	3	RDQ67	T	PR83A	3	RDQ80	T
AA26	PR69B	3	RDQ67	C (LVDS)*	PR82B	3	RDQ80	C (LVDS)*
Y26	PR69A	3	RDQ67	T (LVDS)*	PR82A	3	RDQ80	T (LVDS)*
U21	PR68B	3	RDQ67	C	PR81B	3	RDQ80	C
VCCIO	VCCIO3	3			VCCIO3	3		
U19	PR68A	3	RDQ67	T	PR81A	3	RDQ80	T
W25	PR67B	3	RDQ67	C (LVDS)*	PR80B	3	RDQ80	C (LVDS)*
W26	PR67A	3	RDQS67	T (LVDS)*	PR80A	3	RDQS80	T (LVDS)*
GND	GNDIO3	-			GNDIO3	-		
V24	PR66B	3	RDQ67	C	PR79B	3	RDQ80	C
V25	PR66A	3	RDQ67	T	PR79A	3	RDQ80	T
V26	PR65B	3	RDQ67	C (LVDS)*	PR78B	3	RDQ80	C (LVDS)*
U26	PR65A	3	RDQ67	T (LVDS)*	PR78A	3	RDQ80	T (LVDS)*
VCCIO	VCCIO3	3			VCCIO3	3		
U22	PR64B	3	RLM0_GPLL_C_FB_A/RDQ67	C	PR77B	3	RLM0_GPLL_C_FB_A/RDQ80	C
U23	PR64A	3	RLM0_GPLL_T_FB_A/RDQ67	T	PR77A	3	RLM0_GPLL_T_FB_A/RDQ80	T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA
(Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO2	-			GNDIO2	-		
L21	PR43B	2	RDQ41	C (LVDS)*	PR56B	2	RDQ54	C (LVDS)*
K22	PR43A	2	RDQ41	T (LVDS)*	PR56A	2	RDQ54	T (LVDS)*
M24	PR42B	2	RDQ41	C	PR55B	2	RDQ54	C
N23	PR42A	2	RDQ41	T	PR55A	2	RDQ54	T
VCCIO	VCCIO2	2			VCCIO2	2		
K26	PR41B	2	RDQ41	C (LVDS)*	PR54B	2	RDQ54	C (LVDS)*
K25	PR41A	2	RDQS41	T (LVDS)*	PR54A	2	RDQS54	T (LVDS)*
M20	PR40B	2	RDQ41	C	PR53B	2	RDQ54	C
GND	GNDIO2	-			GNDIO2	-		
M19	PR40A	2	RDQ41	T	PR53A	2	RDQ54	T
L22	PR39B	2	RDQ41	C (LVDS)*	PR52B	2	RDQ54	C (LVDS)*
M22	PR39A	2	RDQ41	T (LVDS)*	PR52A	2	RDQ54	T (LVDS)*
K21	PR38B	2	RDQ41	C	PR51B	2	RDQ54	C
VCCIO	VCCIO2	2			VCCIO2	2		
M21	PR38A	2	RDQ41	T	PR51A	2	RDQ54	T
K24	PR37B	2	RDQ41	C (LVDS)*	PR50B	2	RDQ54	C (LVDS)*
J24	PR37A	2	RDQ41	T (LVDS)*	PR50A	2	RDQ54	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
VCCIO	VCCIO2	2			VCCIO2	2		
L20	VCCPLL	2			NC	-		
GND	GNDIO2	-			GNDIO2	-		
J26	PR26B	2	RUM0_SPLLC_FB_A/RDQ24	C	PR39B	2	RUM0_SPLLC_FB_A/RDQ37	C
J25	PR26A	2	RUM0_SPLLT_FB_A/RDQ24	T	PR39A	2	RUM0_SPLLT_FB_A/RDQ37	T
J23	PR25B	2	RUM0_SPLLC_IN_A/RDQ24	C	PR38B	2	RUM0_SPLLC_IN_A/RDQ37	C
K23	PR25A	2	RUM0_SPLLT_IN_A/RDQ24	T	PR38A	2	RUM0_SPLLT_IN_A/RDQ37	T
VCCIO	VCCIO2	2			VCCIO2	2		
H26	PR24B	2	RDQ24	C (LVDS)*	PR37B	2	RDQ37	C (LVDS)*
H25	PR24A	2	RDQS24***	T (LVDS)*	PR37A	2	RDQS37***	T (LVDS)*
H24	PR23B	2	RDQ24	C	PR36B	2	RDQ37	C
GND	GNDIO2	-			GNDIO2	-		
H23	PR23A	2	RDQ24	T	PR36A	2	RDQ37	T
VCCIO	VCCIO2	2			VCCIO2	2		
G26	PR19B	2	RDQ16	C	PR32B	2	RDQ29	C
GND	GNDIO2	-			GNDIO2	-		
G25	PR19A	2	RDQ16	T	PR32A	2	RDQ29	T
F26	PR18B	2	RDQ16	C (LVDS)*	PR31B	2	RDQ29	C (LVDS)*
F25	PR18A	2	RDQ16	T (LVDS)*	PR31A	2	RDQ29	T (LVDS)*
K20	PR17B	2	RDQ16	C	PR30B	2	RDQ29	C
VCCIO	VCCIO2	2			VCCIO2	2		
L19	PR17A	2	RDQ16	T	PR30A	2	RDQ29	T
E26	PR16B	2	RDQ16	C (LVDS)*	PR29B	2	RDQ29	C (LVDS)*
E25	PR16A	2	RDQS16	T (LVDS)*	PR29A	2	RDQS29	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
J22	PR15B	2	RDQ16	C	PR28B	2	RDQ29	C
H22	PR15A	2	RDQ16	T	PR28A	2	RDQ29	T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
C20	PT75B	1		C	PT93B	1		C
D20	PT75A	1		T	PT93A	1		T
A22	PT74B	1		C	PT92B	1		C
A21	PT74A	1		T	PT92A	1		T
GND	GNDIO1	-			GNDIO1	-		
E19	PT71B	1		C	PT85B	1		C
C19	PT71A	1		T	PT85A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
B21	PT70B	1		C	PT79B	1		C
B20	PT70A	1		T	PT79A	1		T
D19	PT69B	1		C	PT78B	1		C
B19	PT69A	1		T	PT78A	1		T
GND	GNDIO1	-			GNDIO1	-		
G17	PT68B	1		C	PT77B	1		C
E18	PT68A	1		T	PT77A	1		T
G19	PT67B	1		C	PT76B	1		C
F17	PT67A	1		T	PT76A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
A20	PT66B	1		C	PT75B	1		C
A19	PT66A	1		T	PT75A	1		T
E17	PT65B	1		C	PT74B	1		C
D18	PT65A	1		T	PT74A	1		T
B18	PT64B	1		C	PT73B	1		C
GND	GNDIO1	-			GNDIO1	-		
A18	PT64A	1		T	PT73A	1		T
E16	PT63B	1		C	PT72B	1		C
G16	PT63A	1		T	PT72A	1		T
F16	PT62B	1		C	PT71B	1		C
VCCIO	VCCIO1	1			VCCIO1	1		
H18	PT62A	1		T	PT71A	1		T
A17	PT61B	1		C	PT70B	1		C
B17	PT61A	1		T	PT70A	1		T
C18	PT60B	1		C	PT69B	1		C
B16	PT60A	1		T	PT69A	1		T
C17	PT59B	1		C	PT68B	1		C
GND	GNDIO1	-			GNDIO1	-		
D17	PT59A	1		T	PT68A	1		T
E15	PT58B	1		C	PT67B	1		C
VCCIO	VCCIO1	1			VCCIO1	1		
G15	PT58A	1		T	PT67A	1		T
A16	PT57B	1		C	PT66B	1		C
B15	PT57A	1		T	PT66A	1		T
D15	PT56B	1		C	PT65B	1		C
F15	PT56A	1		T	PT65A	1		T
A14	PT55B	1		C	PT64B	1		C
B14	PT55A	1		T	PT64A	1		T

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
A2	PL2A	7	LDQ6	T (LVDS)*	PL2A	7	LDQ6	T (LVDS)*	
B2	PL2B	7	LDQ6	C (LVDS)*	PL2B	7	LDQ6	C (LVDS)*	
D3	PL3A	7	LDQ6	T	PL3A	7	LDQ6	T	
C2	PL3B	7	LDQ6	C	PL3B	7	LDQ6	C	
E4	PL4A	7	LDQ6	T (LVDS)*	PL4A	7	LDQ6	T (LVDS)*	
VCCIO	VCCIO7	7			VCCIO7	7			
E5	PL4B	7	LDQ6	C (LVDS)*	PL4B	7	LDQ6	C (LVDS)*	
B1	PL5A	7	LDQ6	T	PL5A	7	LDQ6	T	
C1	PL5B	7	LDQ6	C	PL5B	7	LDQ6	C	
D2	PL6A	7	LDQS6	T (LVDS)*	PL6A	7	LDQS6	T (LVDS)*	
GNDIO	GNDIO7	-			GNDIO7	-			
D1	PL6B	7	LDQ6	C (LVDS)*	PL6B	7	LDQ6	C (LVDS)*	
E1	PL7A	7	LDQ6	T	PL7A	7	LDQ6	T	
F1	PL7B	7	LDQ6	C	PL7B	7	LDQ6	C	
VCCIO	VCCIO7	7			VCCIO7	7			
F3	PL8A	7	LDQ6	T (LVDS)*	PL8A	7	LDQ6	T (LVDS)*	
F2	PL8B	7	LDQ6	C (LVDS)*	PL8B	7	LDQ6	C (LVDS)*	
F6	PL9A	7	VREF2_7/LDQ6	T	PL9A	7	VREF2_7/LDQ6	T	
F5	PL9B	7	VREF1_7/LDQ6	C	PL9B	7	VREF1_7/LDQ6	C	
GNDIO	GNDIO7	-			GNDIO7	-			
G4	PL11A	7	LUM0_SPLLT_IN_A	T (LVDS)*	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*	
G3	PL11B	7	LUM0_SPLLC_IN_A	C (LVDS)*	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*	
G1	PL12A	7	LUM0_SPLLT_FB_A	T	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T	
G2	PL12B	7	LUM0_SPLLC_FB_A	C	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C	
H1	PL13A	7		T (LVDS)*	PL13A	7	LDQ15	T (LVDS)*	
VCCIO	VCCIO7	7			VCCIO7	7			
J1	PL13B	7		C (LVDS)*	PL13B	7	LDQ15	C (LVDS)*	
H2	PL14A	7		T	PL14A	7	LDQ15	T	
H3	PL14B	7		C	PL14B	7	LDQ15	C	
GNDIO	GNDIO7	-			GNDIO7	-			
VCCIO	VCCIO7	7			VCCIO7	7			
G6	PL24A	7	LDQ22	T (LVDS)*	PL34A	7	LDQ32	T (LVDS)*	
H6	PL24B	7	LDQ22	C (LVDS)*	PL34B	7	LDQ32	C (LVDS)*	
J2	PL25A	7	PCLKT7_0/LDQ22	T	PL35A	7	PCLKT7_0/LDQ32	T	
GNDIO	GNDIO7	-			GNDIO7	-			
K1	PL25B	7	PCLKC7_0/LDQ22	C	PL35B	7	PCLKC7_0/LDQ32	C	
H4	PL27A	6	PCLKT6_0	T (LVDS)*	PL37A	6	PCLKT6_0	T (LVDS)*	
H5	PL27B	6	PCLKC6_0	C (LVDS)*	PL37B	6	PCLKC6_0	C (LVDS)*	
J4	PL28A	6	VREF2_6	T	PL38A	6	VREF2_6	T	
K4	PL28B	6	VREF1_6	C	PL38B	6	VREF1_6	C	
VCCIO	VCCIO6	6			VCCIO6	6			
J6	PL31A	6	LLM1_SPLLT_IN_A	T (LVDS)*	PL41A	6	LLM2_SPLLT_IN_A	T (LVDS)*	
GNDIO	GNDIO6	-			GNDIO6	-			
J5	PL31B	6	LLM1_SPLLC_IN_A	C (LVDS)*	PL41B	6	LLM2_SPLLC_IN_A	C (LVDS)*	
K3	PL32A	6	LLM1_SPLLT_FB_A	T	PL42A	6	LLM2_SPLLT_FB_A	T	
K2	PL32B	6	LLM1_SPLLC_FB_A	C	PL42B	6	LLM2_SPLLC_FB_A	C	
VCCIO	VCCIO6	6			VCCIO6	6			

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
N11	CCLK	8			CCLK	8			
M11	INITN	8			INITN	8			
N13	DONE	8			DONE	8			
GNDIO	GNDIO8	-			GNDIO8	-			
M12	PR53B	8	WRITEN	C	PR68B	8	WRITEN	C	
M13	PR53A	8	CS1N	T	PR68A	8	CS1N	T	
N14	PR52B	8	CSN	C	PR67B	8	CSN	C	
N15	PR52A	8	D0/SPIFASTN	T	PR67A	8	D0/SPIFASTN	T	
VCCIO	VCCIO8	8			VCCIO8	8			
N16	PR51B	8	D1	C	PR66B	8	D1	C	
M16	PR51A	8	D2	T	PR66A	8	D2	T	
L12	PR50B	8	D3	C	PR65B	8	D3	C	
GNDIO	GNDIO8	-			GNDIO8	-			
L13	PR50A	8	D4	T	PR65A	8	D4	T	
L16	PR49B	8	D5	C	PR64B	8	D5	C	
K16	PR49A	8	D6	T	PR64A	8	D6	T	
L14	PR48B	8	D7/SPID0***	C	PR63B	8	D7/SPID0***	C	
VCCIO	VCCIO8	8			VCCIO8	8			
L15	PR48A	8	DI/CSSPI0N	T	PR63A	8	DI/CSSPI0N	T	
K13	PR47B	8	DOUT/CSN/CSSPI1N	C	PR62B	8	DOUT/CSN/CSSPI1N	C	
K14	PR47A	8	BUSY/SISPI	T	PR62A	8	BUSY/SISPI	T	
K11	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
K15	PR45B	3	RLM0_GDLLC_FB_A	C	PR60B	3	RLM0_GDLLC_FB_A/RDQ57	C	
GNDIO	GNDIO3	-			GNDIO3	-			
J16	PR45A	3	RLM0_GDLLT_FB_A	T	PR60A	3	RLM0_GDLLT_FB_A/RDQ57	T	
H16	PR44B	3	RLM0_GDLLC_IN_A	C (LVDS)*	PR59B	3	RLM0_GDLLC_IN_A**/RDQ57	C (LVDS)*	
J15	PR44A	3	RLM0_GDLLT_IN_A	T (LVDS)*	PR59A	3	RLM0_GDLLT_IN_A**/RDQ57	T (LVDS)*	
J14	PR43B	3	RLM0_GPLL_C_IN_A	C	PR58B	3	RLM0_GPLL_C_IN_A**/RDQ57	C	
VCCIO	VCCIO3	3			VCCIO3	3			
J13	PR43A	3	RLM0_GPLLT_IN_A	T	PR58A	3	RLM0_GPLLT_IN_A**/RDQ57	T	
H13	PR42B	3	RLM0_GPLL_C_FB_A	C (LVDS)*	PR57B	3	RLM0_GPLL_C_FB_A/RDQ57	C (LVDS)*	
H12	PR42A	3	RLM0_GPLLT_FB_A	T (LVDS)*	PR57A	3	RLM0_GPLLT_FB_A/RDQ57***	T (LVDS)*	
GNDIO	GNDIO3	-			GNDIO3	-			
VCCIO	VCCIO3	3			VCCIO3	3			
G16	PR32B	3	RLM1_SPLLC_FB_A	C	PR42B	3	RLM2_SPLLC_FB_A	C	
VCCIO	VCCIO3	3			VCCIO3	3			
H15	PR32A	3	RLM1_SPLLT_FB_A	T	PR42A	3	RLM2_SPLLT_FB_A	T	
E16	PR31B	3	RLM1_SPLLC_IN_A	C (LVDS)*	PR41B	3	RLM2_SPLLC_IN_A	C (LVDS)*	
F15	PR31A	3	RLM1_SPLLT_IN_A	T (LVDS)*	PR41A	3	RLM2_SPLLT_IN_A	T (LVDS)*	
GNDIO	GNDIO3	-			GNDIO3	-			
VCCIO	VCCIO3	3			VCCIO3	3			
F16	PR28B	3	VREF2_3	C	PR38B	3	VREF2_3	C	
G15	PR28A	3	VREF1_3	T	PR38A	3	VREF1_3	T	
J11	PR27B	3	PCLKC3_0	C (LVDS)*	PR37B	3	PCLKC3_0	C (LVDS)*	
J12	PR27A	3	PCLKT3_0	T (LVDS)*	PR37A	3	PCLKT3_0	T (LVDS)*	
G14	PR25B	2	PCLKC2_0/RDQ22	C	PR35B	2	PCLKC2_0/RDQ32	C	
G13	PR25A	2	PCLKT2_0/RDQ22	T	PR35A	2	PCLKT2_0/RDQ32	T	
GNDIO	GNDIO2	-			GNDIO2	-			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
H14	PT61A	0		T
A14	PT60B	0		C
B14	PT60A	0		T
D13	PT59B	0		C
GNDIO	GNDIO0	-		
F13	PT59A	0		T
G13	PT58B	0		C
VCCIO	VCCIO0	0		
J11	PT58A	0		T
D4	PT57B	0		
D5	PT56A	0		
E5	PT55B	0		C
F6	PT55A	0		T
GNDIO	GNDIO0	-		
VCCIO	VCCIO0	0		
F7	PT52B	0		C
D8	PT52A	0		T
GNDIO	GNDIO0	-		
J13	PT50B	0		C
G11	PT50A	0		T
H13	PT49B	0		C
H12	PT49A	0		T
VCCIO	VCCIO0	0		
E8	PT48B	0		C
D9	PT48A	0		T
D12	PT46B	0		C
GNDIO	GNDIO0	-		
E13	PT46A	0		T
VCCIO	VCCIO0	0		
GNDIO	GNDIO0	-		
J12	PT31B	0		C
-	-	-		
VCCIO	VCCIO0	0		
H10	PT31A	0		T
E12	PT30B	0		C
D11	PT30A	0		T
H11	PT29B	0		C
F11	PT29A	0		T
C13	ULC_SQ_VCCR0	11		
A12	ULC_SQ_HDINP0	11		T
B13	ULC_SQ_VCCIB0	11		
B12	ULC_SQ_HDINN0	11		C
C10	ULC_SQ_VCCTX0	11		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
P31	NC	-			PR39B	2		C (LVDS)*
P32	NC	-			PR39A	2		T (LVDS)*
R25	NC	-			PR38B	2		C
-	-	-			VCCIO2	2		
T24	NC	-			PR38A	2		T
N34	NC	-			PR37B	2		C (LVDS)*
N33	NC	-			PR37A	2		T (LVDS)*
GNDIO	GNDIO2	-			GNDIO2	-		
M34	PR31B	2	RDQ28	C	PR35B	2	RDQ32	C
M33	PR31A	2	RDQ28	T	PR35A	2	RDQ32	T
-	-	-			GNDIO2	-		
R24	PR30B	2	RDQ28	C (LVDS)*	PR34B	2	RDQ32	C (LVDS)*
P24	PR30A	2	RDQ28	T (LVDS)*	PR34A	2	RDQ32	T (LVDS)*
N30	PR29B	2	RDQ28	C	PR33B	2	RDQ32	C
M29	PR29A	2	RDQ28	T	PR33A	2	RDQ32	T
VCCIO	VCCIO2	2			VCCIO2	2		
N28	PR28B	2	RDQ28	C (LVDS)*	PR32B	2	RDQ32	C (LVDS)*
N29	PR28A	2	RDQS28	T (LVDS)*	PR32A	2	RDQS32	T (LVDS)*
N24	PR27B	2	RDQ28	C	PR31B	2	RDQ32	C
GNDIO	GNDIO2	-			GNDIO2	-		
N25	PR27A	2	RDQ28	T	PR31A	2	RDQ32	T
M28	PR26B	2	RDQ28	C (LVDS)*	PR30B	2	RDQ32	C (LVDS)*
M27	PR26A	2	RDQ28	T (LVDS)*	PR30A	2	RDQ32	T (LVDS)*
L27	PR25B	2	RDQ28	C	PR29B	2	RDQ32	C
VCCIO	VCCIO2	2			VCCIO2	2		
M26	PR25A	2	RDQ28	T	PR29A	2	RDQ32	T
M32	PR24B	2	RDQ28	C (LVDS)*	PR28B	2	RDQ32	C (LVDS)*
M31	PR24A	2	RDQ28	T (LVDS)*	PR28A	2	RDQ32	T (LVDS)*
GNDIO	GNDIO2	-			GNDIO2	-		
-	-	-			VCCIO2	2		
L34	PR22B	2		C	PR22B	2	RDQ23	C
L33	PR22A	2		T	PR22A	2	RDQ23	T
L32	PR21B	2		C (LVDS)*	PR21B	2	RDQ23	C (LVDS)*
L31	PR21A	2		T (LVDS)*	PR21A	2	RDQ23	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO2	2		
L28	PR20B	2		C	PR20B	2	RDQ23	C
L29	PR20A	2		T	PR20A	2	RDQ23	T
M30	PR19B	2		C (LVDS)*	PR19B	2	RDQ23	C (LVDS)*
L30	PR19A	2		T (LVDS)*	PR19A	2	RDQ23	T (LVDS)*
K34	PR18B	2	RDQ15	C	PR18B	2	RDQ15	C
K33	PR18A	2	RDQ15	T	PR18A	2	RDQ15	T
GNDIO	GNDIO2	-			GNDIO2	-		
K30	PR17B	2	RDQ15	C (LVDS)*	PR17B	2	RDQ15	C (LVDS)*
K29	PR17A	2	RDQ15	T (LVDS)*	PR17A	2	RDQ15	T (LVDS)*
J34	PR16B	2	RDQ15	C	PR16B	2	RDQ15	C
J33	PR16A	2	RDQ15	T	PR16A	2	RDQ15	T
VCCIO	VCCIO2	2			VCCIO2	2		
J32	PR15B	2	RDQ15	C (LVDS)*	PR15B	2	RDQ15	C (LVDS)*
J31	PR15A	2	RDQS15	T (LVDS)*	PR15A	2	RDQS15	T (LVDS)*

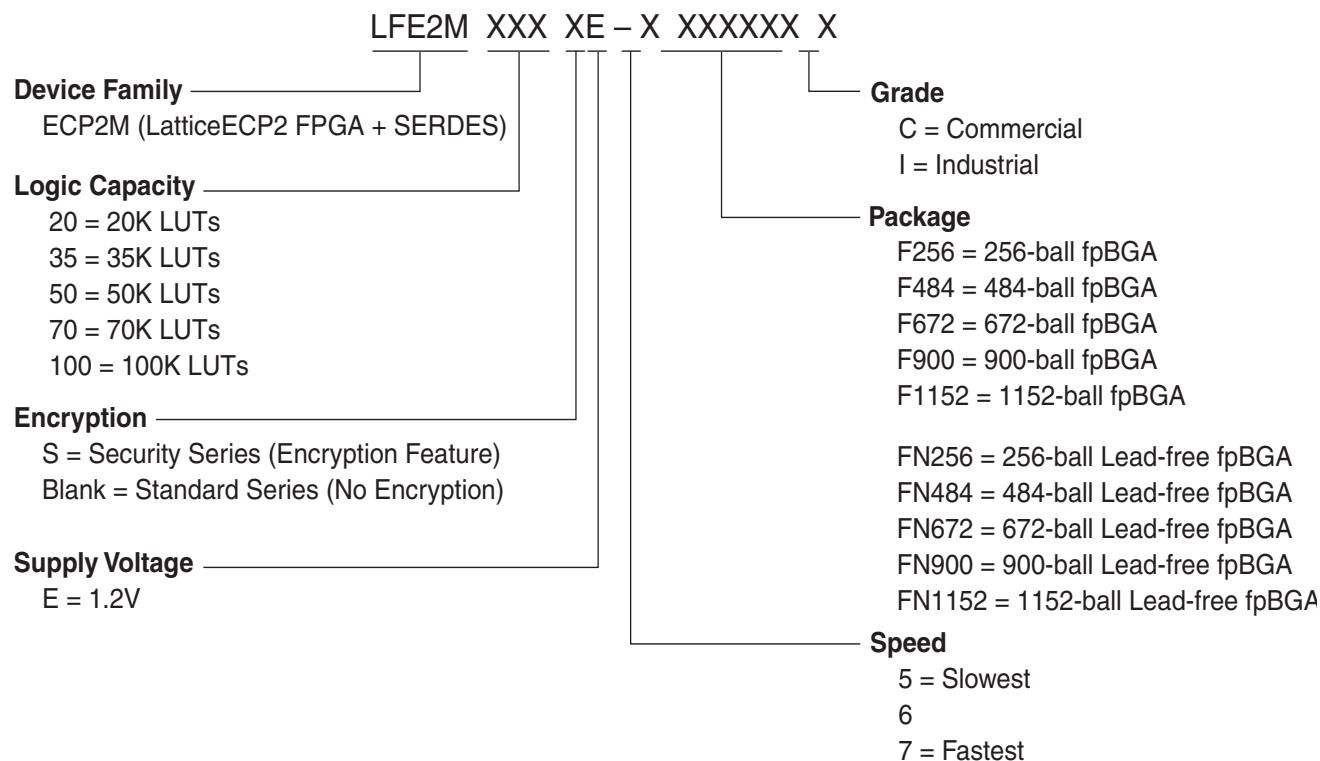
Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20SE-5Q208I	131	1.2V	-5	PQFP	208	Ind	20
LFE2-20SE-6Q208I	131	1.2V	-6	PQFP	208	Ind	20
LFE2-20SE-5F256I	193	1.2V	-5	fpBGA	256	Ind	20
LFE2-20SE-6F256I	193	1.2V	-6	fpBGA	256	Ind	20
LFE2-20SE-5F484I	331	1.2V	-5	fpBGA	484	Ind	20
LFE2-20SE-6F484I	331	1.2V	-6	fpBGA	484	Ind	20
LFE2-20SE-5F672I	402	1.2V	-5	fpBGA	672	Ind	20
LFE2-20SE-6F672I	402	1.2V	-6	fpBGA	672	Ind	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35SE-5F484I	331	1.2V	-5	fpBGA	484	Ind	35
LFE2-35SE-6F484I	331	1.2V	-6	fpBGA	484	Ind	35
LFE2-35SE-5F672I	450	1.2V	-5	fpBGA	672	Ind	35
LFE2-35SE-6F672I	450	1.2V	-6	fpBGA	672	Ind	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50SE-5F484I	339	1.2V	-5	fpBGA	484	Ind	50
LFE2-50SE-6F484I	339	1.2V	-6	fpBGA	484	Ind	50
LFE2-50SE-5F672I	500	1.2V	-5	fpBGA	672	Ind	50
LFE2-50SE-6F672I	500	1.2V	-6	fpBGA	672	Ind	50

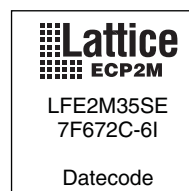
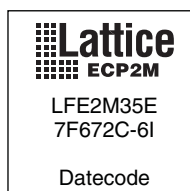
Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70SE-5F672I	500	1.2V	-5	fpBGA	672	Ind	70
LFE2-70SE-6F672I	500	1.2V	-6	fpBGA	672	Ind	70
LFE2-70SE-5F900I	583	1.2V	-5	fpBGA	900	Ind	70
LFE2-70SE-6F900I	583	1.2V	-6	fpBGA	900	Ind	70

LatticeECP2M Part Number Description



Ordering Information

Note: LatticeECP2M devices are dual marked. For example, the commercial speed grade LFE2M50E-7F672C is also marked with industrial grade -6I (LFE2M50E-6F672I). The commercial grade is one speed grade faster than the associated dual mark industrial grade. The slowest commercial grade does not have industrial markings. The markings appear as follows:



Date	Version	Section	Change Summary
August 2007 (cont.)	02.8 (cont.)	DC and Switching (cont.)	sysCLOCK GPLL timing has been updated.
		Pinout Information	Added ECP2M50 (484/672/900-fpBGA), ECP2M70 (900-fpBGA) and ECP2M100 (900-fpBGA) pinout information.
		Ordering Information	1156-fpBGA package option has been removed from the LatticeECP2M family.
September 2007	02.9	Pinout Information	Added Thermal Management text section.
February 2008	03.0	Architecture	Added LVCMOS33D description.
		DC and Switching	LatticeECP2M Supply Current has been updated.
			Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLL Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.11).
			Figure 3-9. Read/Write Mode (Normal) and Figure 3-10. Read/Write Mode with Input and Output Registers have been updated.
			Table 3-8. Channel output Jitter (Max) has been updated.
		Pinout Information	Signal description has been updated.
April 2008	03.1	Pinout Information	Added 1152-fpBGA pinouts for the ECP2M70 and ECP2M100.
June 2008	03.2	Pinout Information	Available DDR Interfaces per I/O Bank for the LFE2M35 (484/672-fpBGA) have been updated.
		Introduction	Family Selection Guide table - Updated number of EBR SRAM Blocks for the ECP2-70 device.
		Architecture	Removed Read-Before-Write sysMEM EBR mode.
		Architecture	Clarification of the operation of the secondary clock regions.
August 2008	03.3	DC and Switching Characteristics	Removed Read-Before-Write sysMEM EBR mode.
		Architecture	Clarification of the operation of the secondary clock regions.
		Pinout Information	Added information for [LOC]DQ[num] to Signal Descriptions table.
January 2009	03.4	DC and Switching Characteristics	Updated typical and max. jitter numbers in Channel Output Jitter table for x10 mode.
			Added Channel Output Jitter table for x20 mode.
November 2009	03.5	DC and Switching Characteristics	Updated SPI/SPI _m Configuration Waveforms diagram.
			Updated footnotes in LatticeECP2 Initialization Supply Current table.
			Updated footnotes in LatticeECP2M Initialization Supply Current table.
			Updated footnotes in SERDES High Speed Data Receiver (LatticeECP2M Family Only) table.
			Updated max. value for t _{DINIT} parameter in LatticeECP2/M sysCONFIG Port Timing Specifications table.
			Updated Serial Output Timing and Levels table.
			Updated Figure 3-5 MLVDS
			Updated Table 3-7 Serial Output Timing and Levels
			Updated Table 3-15 Power Down/Power Up Specification
		Pinout Information	Signal Descriptions table - corrected references to ULM, URM, LRM (changed to LUM, RUM and RLM), added footnote 5.